



PELLICULE

ペリキュールLCP

PELLICULE LCP

以特殊成形方法、分子配向控制技术来实现液晶聚合物树脂的薄膜化!!

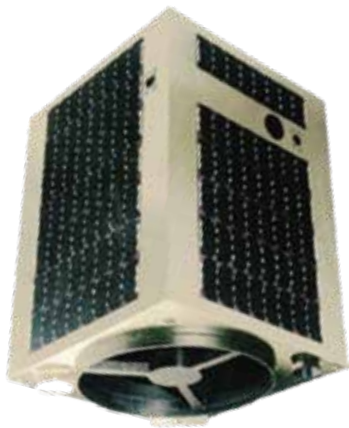
Creation of LCP film using special molding methods and control of molecular orientation.

液晶聚合物薄膜

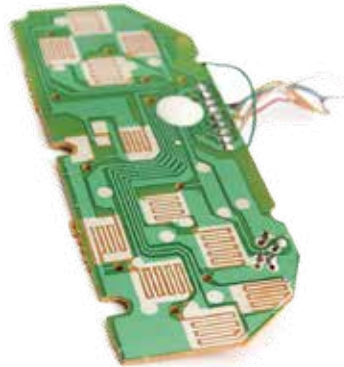
卓越的耐热及绝缘! 以原料颗粒来进行薄膜化加工

Liquid Crystal Polymer (LCP) Film

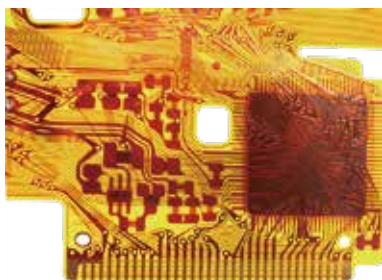
Exceeding in heat-resistance and insulation! Film processed from pellets



特殊耐热绝缘材
Special heat-resistant insulating material



耐热工程材料
Heat-resistant process material



- 机械特性及电气特性优良
- 不含卤素成分
- 耐热性优良
- 阻气性优良
- 吸水率极低
- 介电特性优良
- 气体产生量极低
- 标准厚度为 0.050mm

- Excellent mechanical and electrical properties
- Halogen-free
- Excellent heat-resistant properties
- Excellent gas barrier properties
- Extremely low water absorption
- Excellent dielectric properties
- Extremely low outgassing
- Standard thickness 0.050mm



用途示例 Usage



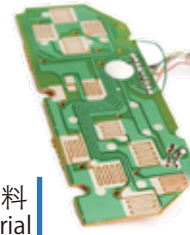
高耐热性
Heat resistance

高绝缘性
High insulation



人造卫星
Satellite

特殊耐热绝缘材
Heat-resistant insulation



工程材料
Process material

高耐热性
Heat-resistance



耐热性工程材料
Heat-resistant process material



介电率低
Low Dk

毫米波雷达
Millimeter-wave radar

高速传输高频机器
High-speed transmission
High-frequency equipment

次世代通信
5G communications



次世代通信装置用电路板材料
Base material for high speed and high-frequency applications



介电损耗低
Low Df

液晶聚合物薄膜

卓越的耐热及绝缘！ 以原料颗粒来进行薄膜化加工

Liquid Crystal Polymer (LCP) Film

Exceeding in heat-resistance and insulation! Film processed from pellets

物性 Physical properties

试验项目 Items	单位 Unit	测量值 Value
抗拉强度 Tensile strength	MPa	290
熔点 Melting temperature	°C	280
绝缘破坏强度 Dielectric strength	KV/mm	210
体积电阻率 Volume resistivity	$\Omega \cdot \text{cm}$	2×10^{16}
相对介电常数(1GHz) Dielectric constant	—	≤ 3.0
介电损耗(1GHz) Dielectric dissipation factor	—	≤ 0.002

※所记载的数值均为测定值，并非保证值。
The above value is measured value, and it's not guaranteed value.

高速传输特性 High speed transmission properties

